## FEATURES

## - Timing From Microseconds to Hours

- Astable or Monostable Operation


## - Adjustable Duty Cycle

- TTL-Compatible Output Can Sink or Source up to $\mathbf{2 0 0} \mathbf{~ m A}$


## DESCRIPTION/ORDERING INFORMATION

These devices are precision timing circuits capable of producing accurate time delays or oscillation. In the time-delay or monostable mode of operation, the timed interval is controlled by a single external resistor and capacitor network. In the astable mode of operation, the frequency and duty cycle can be controlled independently with two external resistors and a single external capacitor.

The threshold and trigger levels normally are two-thirds and one-third, respectively, of $\mathrm{V}_{\mathrm{cc}}$. These levels can be altered by use of the control-voltage terminal. When the trigger input falls below the trigger level, the flip-flop is set, and the output goes high. If the trigger input is above the trigger level and the threshold input is above the threshold level, the flip-flop is reset and the output is low. The reset (RESET) input can override all other inputs and can be used to initiate a new timing cycle. When RESET goes low, the flip-flop is reset, and the output goes low. When the output is low, a low-impedance path is provided between discharge (DISCH) and ground.
The output circuit is capable of sinking or sourcing current up to 200 mA . Operation is specified for supplies of 5 V to 15 V . With a 5-V supply, output levels are compatible with TTL inputs.


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

ORDERING INFORMATION

| TA | $\begin{gathered} \mathrm{V}_{\text {THRES }} \\ \text { MAX } \\ \mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V} \\ \hline \end{gathered}$ | PACKAGE ${ }^{(1)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | 11.2 V | PDIP - P | Tube of 50 | NE555P | NE555P |
|  |  | SOIC - D | Tube of 75 | NE555D | NE555 |
|  |  |  | Reel of 2500 | NE555DR |  |
|  |  | SOP - PS | Reel of 2000 | NE555PSR | N555 |
|  |  | TSSOP - PW | Tube of 150 | NE555PW | N555 |
|  |  |  | Reel of 2000 | NE555PWR |  |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | 11.2 V | PDIP - P | Tube of 50 | SA555P | SA555P |
|  |  | SOIC - D | Tube of 75 | SA555D | SA555 |
|  |  |  | Reel of 2000 | SA555DR |  |
| $-40^{\circ} \mathrm{C}$ to $105^{\circ} \mathrm{C}$ | 11.2 V | PDIP - P | Tube of 50 | NA555P | NA555P |
|  |  | SOIC - D | Tube of 75 | NA555D | NA555 |
|  |  |  | Reel of 2000 | NA555DR |  |
| $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 10.6 | PDIP - P | Tube of 50 | SE555P | SE555P |
|  |  | SOIC - D | Tube of 75 | SE555D | SE555D |
|  |  |  | Reel of 2500 | SE555DR |  |
|  |  | CDIP - JG | Tube of 50 | SE555JG | SE555JG |
|  |  | LCCC - FK | Tube of 55 | SE555FK | SE555FK |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| RESET | TRIGGER VOLTAGE ${ }^{(1)}$ | THRESHOLD VOLTAGE ${ }^{(1)}$ | OUTPUT | DISCHARGE SWITCH |
| :---: | :---: | :---: | :---: | :---: |
| Low | Irrelevant | Irrelevant | Low | On |
| High | $<1 / 3 V_{D D}$ | Irrelevant | High | Off |
| High | $>1 / 3 V_{D D}$ | $>2 / 3 V_{D D}$ | Low | On |
| High | $>1 / 3 \mathrm{~V}_{\mathrm{DD}}$ | $<2 / 3 V_{D D}$ | As previously established |  |

(1) Voltage levels shown are nominal.

FUNCTIONAL BLOCK DIAGRAM


Pin numbers shown are for the D, JG, P, PS, and PW packages. NOTE A: RESET can override TRIG, which can override THRES. PRECISION TIMERS

## Absolute Maximum Ratings ${ }^{(1)}$

over operating free-air temperature range (unless otherwise noted)

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltage values are with respect to GND.
(3) Maximum power dissipation is a function of $T_{J}(\max ), \theta_{\mathrm{JA}}$, and $\mathrm{T}_{\mathrm{A}}$. The maximum allowable power dissipation at any allowable ambient temperature is $P_{D}=\left(T_{J}(\max )-T_{A}\right) / \theta_{J A}$. Operating at the absolute maximum $T_{J}$ of $150^{\circ} \mathrm{C}$ can affect reliability.
(4) The package thermal impedance is calculated in accordance with JESD 51-7.
(5) Maximum power dissipation is a function of $T_{J}(\max ), \theta_{J c}$, and $T_{C}$. The maximum allowable power dissipation at any allowable case temperature is $P_{D}=\left(T_{J}(\max )-T_{C}\right) / \theta_{J c}$. Operating at the absolute maximum $T_{J}$ of $150^{\circ} \mathrm{C}$ can affect reliability.
(6) The package thermal impedance is calculated in accordance with MIL-STD-883.

## Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | NA555, NE555, SA555 | 4.5 | 16 |  |
| $V_{C C}$ | Supply vorage | SE555 | 4.5 | 18 | V |
| V | Input voltage | CONT, RESET, THRES, and TRIG |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| $\mathrm{I}_{0}$ | Output current |  |  | $\pm 200$ | mA |
|  |  | NA555 | -40 | 105 |  |
|  | erating free-air temperature | NE555 | 0 | 70 |  |
| $\mathrm{T}_{\text {A }}$ | erating free-air temperature | SA555 | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | SE555 | -55 | 125 |  |

## Electrical Characteristics

$\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ to $15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | SE555 |  |  | NA555 NE555 SA555 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| THRES voltage level | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ |  | 9.4 | 10 | 10.6 | 8.8 | 10 | 11.2 | V |
|  | $\mathrm{V}_{C C}=5 \mathrm{~V}$ |  | 2.7 | 3.3 | 4 | 2.4 | 3.3 | 4.2 |  |
| THRES current ${ }^{(1)}$ |  |  |  | 30 | 250 |  | 30 | 250 | nA |
| TRIG voltage level | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ |  | 4.8 | 5 | 5.2 | 4.5 | 5 | 5.6 | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 3 |  | 6 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  | 1.45 | 1.67 | 1.9 | 1.1 | 1.67 | 2.2 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 1.9 |  |  |  |  |
| TRIG current | TRIG at 0 V |  |  | 0.5 | 0.9 |  | 0.5 | 2 | $\mu \mathrm{A}$ |
| RESET voltage level |  |  | 0.3 | 0.7 | 1 | 0.3 | 0.7 | 1 | V |
|  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  |  | 1.1 |  |  |  |  |
| RESET current | RESET at $\mathrm{V}_{\mathrm{CC}}$ |  |  | 0.1 | 0.4 |  | 0.1 | 0.4 | mA |
|  | RESET at 0 V |  |  | -0.4 | -1 |  | -0.4 | -1.5 |  |
| DISCH switch off-state current |  |  |  | 20 | 100 |  | 20 | 100 | nA |
| CONT voltage (open circuit) | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ |  | 9.6 | 10 | 10.4 | 9 | 10 | 11 | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 9.6 |  | 10.4 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  | 2.9 | 3.3 | 3.8 | 2.6 | 3.3 | 4 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 2.9 |  | 3.8 |  |  |  |  |
| Low-level output voltage | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{l}_{\mathrm{OL}}=10 \mathrm{~mA}$ |  |  | 0.1 | 0.15 |  | 0.1 | 0.25 | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 0.2 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=50 \mathrm{~mA}$ |  |  | 0.4 | 0.5 |  | 0.4 | 0.75 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 1 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{l}_{\mathrm{OL}}=100 \mathrm{~mA}$ |  |  | 2 | 2.2 |  | 2 | 2.5 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 2.7 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=200 \mathrm{~mA}$ |  |  | 2.5 |  |  | 2.5 |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=3.5 \mathrm{~mA}$ | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 0.35 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=5 \mathrm{~mA}$ |  |  | 0.1 | 0.2 |  | 0.1 | 0.35 |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |  |  | 0.8 |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=8 \mathrm{~mA}$ |  |  | 0.15 | 0.25 |  | 0.15 | 0.4 |  |
| High-level output voltage | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=-100 \mathrm{~mA}$ |  | 13 | 13.3 |  | 12.75 | 13.3 |  | V |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 12 |  |  |  |  |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-200 \mathrm{~mA}$ |  |  | 12.5 |  |  | 12.5 |  |  |
|  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=-100 \mathrm{~mA}$ |  | 3 | 3.3 |  | 2.75 | 3.3 |  |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | 2 |  |  |  |  |  |  |
| Supply current | Output low, No load | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ |  | 10 | 12 |  | 10 | 15 | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  | 3 | 5 |  | 3 | 6 |  |
|  | Output high, No load | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ |  | 9 | 10 |  | 9 | 13 |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  | 2 | 4 |  | 2 | 5 |  |

(1) This parameter influences the maximum value of the timing resistors $R_{A}$ and $R_{B}$ in the circuit of Figure 12. For example, when $V_{C C}=5 \mathrm{~V}$, the maximum value is $R=R_{A}+R_{B} \approx 3.4 \mathrm{M} \Omega$, and for $V_{C C}=15 \mathrm{~V}$, the maximum value is $10 \mathrm{M} \Omega$.

## Operating Characteristics

$\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ to $15 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  | TEST <br> CONDITIONS ${ }^{(1)}$ | SE555 |  |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Initial error of timing | Each timer, monostable ${ }^{(3)}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 0.5 | $1.5{ }^{(4)}$ |  | 1 | 3 | \% |
| interval ${ }^{(2)}$ | Each timer, astable ${ }^{(5)}$ |  |  | 1.5 |  |  | 2.25 |  |  |  |
| Temperature coefficient of timing interval | Each timer, monostable ${ }^{(3)}$ | $\mathrm{T}_{\mathrm{A}}=\mathrm{MIN}$ to MAX |  | 30 | $100{ }^{(4)}$ |  | 50 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |  |
|  | Each timer, astable ${ }^{(5)}$ |  |  | 90 |  |  | 150 |  |  |  |
| Supply-voltage sensitivity of timing interval | Each timer, monostable ${ }^{(3)}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 0.05 | $0.2{ }^{(4)}$ |  | 0.1 | 0.5 | \%/V |  |
|  | Each timer, astable ${ }^{(5)}$ |  | 0.15 |  |  | 0.3 |  |  |  |  |
| Output-pulse rise time |  | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  | 100 | $200{ }^{(4)}$ |  | 100 | 300 | ns |  |
| Output-pulse fall time |  | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  | 100 | $200{ }^{(4)}$ |  | 100 | 300 | ns |  |

(1) For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
(2) Timing interval error is defined as the difference between the measured value and the average value of a random sample from each process run.
(3) Values specified are for a device in a monostable circuit similar to Figure 9, with the following component values: $\mathrm{R}_{\mathrm{A}}=2 \mathrm{k} \Omega$ to $100 \mathrm{k} \Omega$, $\mathrm{C}=0.1 \mu \mathrm{~F}$.
(4) On products compliant to MIL-PRF-38535, this parameter is not production tested.
(5) Values specified are for a device in an astable circuit similar to Figure 12, with the following component values: $R_{A}=1 \mathrm{k} \Omega$ to $100 \mathrm{k} \Omega$, $\mathrm{C}=0.1 \mu \mathrm{~F}$.
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TYPICAL CHARACTERISTICS
Data for temperatures below $0^{\circ} \mathrm{C}$ and above $70^{\circ} \mathrm{C}$ are applicable for SE555 circuits only.


Figure 1.


Figure 3.

Figure 2.
DROP BETWEEN SUPPLY VOLTAGE AND OUTPUT vs
HIGH-LEVEL OUTPUT CURRENT


Figure 4.

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## TYPICAL CHARACTERISTICS (continued)

Data for temperatures below $0^{\circ} \mathrm{C}$ and above $70^{\circ} \mathrm{C}$ are applicable for SE555 circuits only.


Figure 5.
NORMALIZED OUTPUT PULSE DURATION (MONOSTABLE OPERATION)
vs
FREE-AIR TEMPERATURE


Figure 7.

NORMALIZED OUTPUT PULSE DURATION (MONOSTABLE OPERATION)

VS
SUPPLY VOLTAGE


Figure 6.
PROPAGATION DELAY TIME
vs
LOWEST VOLTAGE LEVEL OF TRIGGER PULSE


Figure 8.

INSTRUMENTS
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## APPLICATION INFORMATION

## Monostable Operation

For monostable operation, any of these timers can be connected as shown in Figure 9. If the output is low, application of a negative-going pulse to the trigger (TRIG) sets the flip-flop ( $\overline{\mathrm{Q}}$ goes low), drives the output high, and turns off Q1. Capacitor $C$ then is charged through $R_{A}$ until the voltage across the capacitor reaches the threshold voltage of the threshold (THRES) input. If TRIG has returned to a high level, the output of the threshold comparator resets the flip-flop ( $\overline{\mathrm{Q}}$ goes high), drives the output low, and discharges C through Q 1 .


Pin numbers shown are for the D, JG, P, PS, and PW packages.
Figure 9. Circuit for Monostable Operation
Monostable operation is initiated when TRIG voltage falls below the trigger threshold. Once initiated, the sequence ends only if TRIG is high at the end of the timing interval. Because of the threshold level and saturation voltage of Q1, the output pulse duration is approximately $t_{w}=1.1 R_{A} C$. Figure 11 is a plot of the time constant for various values of $\mathrm{R}_{\mathrm{A}}$ and C . The threshold levels and charge rates both are directly proportional to the supply voltage, $\mathrm{V}_{\mathrm{Cc}}$. The timing interval is, therefore, independent of the supply voltage, so long as the supply voltage is constant during the time interval.

Applying a negative-going trigger pulse simultaneously to RESET and TRIG during the timing interval discharges C and reinitiates the cycle, commencing on the positive edge of the reset pulse. The output is held low as long as the reset pulse is low. To prevent false triggering, when RESET is not used, it should be connected to $\mathrm{V}_{\mathrm{CC}}$.

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## APPLICATION INFORMATION (continued)



Time - $0.1 \mathrm{~ms} / \mathrm{div}$
Figure 10. Typical Monostable Waveforms


Figure 11. Output Pulse Duration vs Capacitance

## Astable Operation

As shown in Figure 12, adding a second resistor, $R_{B}$, to the circuit of Figure 9 and connecting the trigger input to the threshold input causes the timer to self-trigger and run as a multivibrator. The capacitor $C$ charges through $R_{A}$ and $R_{B}$ and then discharges through $R_{B}$ only. Therefore, the duty cycle is controlled by the values of $R_{A}$ and $\mathrm{R}_{\mathrm{B}}$.

This astable connection results in capacitor $C$ charging and discharging between the threshold-voltage level $\left(\approx 0.67 \times \mathrm{V}_{c c}\right)$ and the trigger-voltage level $\left(\approx 0.33 \times \mathrm{V}_{c c}\right)$. As in the monostable circuit, charge and discharge times (and, therefore, the frequency and duty cycle) are independent of the supply voltage.


Pin numbers shown are for the D, JG, P, PS, and PW packages. NOTE A: Decoupling CONT voltage to ground with a capacitor can improve operation. This should be evaluated for individual applications.

Figure 12. Circuit for Astable Operation


Time - $0.5 \mathrm{~ms} /$ div
Figure 13. Typical Astable Waveforms

## APPLICATION INFORMATION (continued)

Figure 13 shows typical waveforms generated during astable operation. The output high-level duration $t_{H}$ and low-level duration $t_{L}$ can be calculated as follows:

$$
\begin{aligned}
& t_{H}=0.693\left(R_{A}+R_{B}\right) \\
& t_{L}=0.693\left(R_{B}\right) C
\end{aligned}
$$

Other useful relationships are shown below.

$$
\begin{aligned}
& \text { period }=t_{H}+t_{L}=0.693\left(R_{A}+2 R_{B}\right) C \\
& \text { frequency } \approx \frac{1.44}{\left(R_{A}+2 R_{B}\right) C} \\
& \text { Output driver duty cycle }=\frac{t_{L}}{t_{H}+t_{L}}=\frac{R_{B}}{R_{A}+2 R_{B}} \\
& \text { Output waveform duty cycle } \\
& \qquad \frac{t_{H}}{t_{H}+t_{L}}=1-\frac{R_{B}}{R_{A}+2 R_{B}} \\
& \text { Low-to-high ratio }=\frac{t_{L}}{t_{H}}=\frac{R_{B}}{R_{A}+R_{B}}
\end{aligned}
$$



Figure 14. Free-Running Frequency

## Missing-Pulse Detector

The circuit shown in Figure 15 can be used to detect a missing pulse or abnormally long spacing between consecutive pulses in a train of pulses. The timing interval of the monostable circuit is retriggered continuously by the input pulse train as long as the pulse spacing is less than the timing interval. A longer pulse spacing, missing pulse, or terminated pulse train permits the timing interval to be completed, thereby generating an output pulse as shown in Figure 16.


Pin numbers shown are shown for the D, JG, P, PS, and PW packages.
Figure 15. Circuit for Missing-Pulse Detector


Time - $0.1 \mathrm{~ms} / \mathrm{div}$
Figure 16. Completed Timing Waveforms for Missing-Pulse Detector

## APPLICATION INFORMATION (continued)

## Frequency Divider

By adjusting the length of the timing cycle, the basic circuit of Figure 9 can be made to operate as a frequency divider. Figure 17 shows a divide-by-three circuit that makes use of the fact that retriggering cannot occur during the timing cycle.


Figure 17. Divide-by-Three Circuit Waveforms
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## APPLICATION INFORMATION (continued)

## Pulse-Width Modulation

The operation of the timer can be modified by modulating the internal threshold and trigger voltages, which is accomplished by applying an external voltage (or current) to CONT. Figure 18 shows a circuit for pulse-width modulation. A continuous input pulse train triggers the monostable circuit, and a control signal modulates the threshold voltage. Figure 19 shows the resulting output pulse-width modulation. While a sine-wave modulation signal is shown, any wave shape could be used.


Pin numbers shown are for the $D, J G, P, P S$, and $P W$ packages.
NOTE A: The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, the effects of modulation source voltage and impedance on the bias of the timer should be considered.

Figure 18. Circuit for Pulse-Width Modulation


Figure 19. Pulse-Width-Modulation Waveforms

## APPLICATION INFORMATION (continued)

## Pulse-Position Modulation

As shown in Figure 20, any of these timers can be used as a pulse-position modulator. This application modulates the threshold voltage and, thereby, the time delay, of a free-running oscillator. Figure 21 shows a triangular-wave modulation signal for such a circuit; however, any wave shape could be used.


Pin numbers shown are for the D, JG, P, PS, and PW packages.
NOTE A: The modulating signal can be direct or capacitively coupled to CONT. For direct coupling, the effects of modulation source voltage and impedance on the bias of the timer should be considered.

Figure 20. Circuit for Pulse-Position Modulation


Figure 21. Pulse-Position-Modulation Waveforms

## APPLICATION INFORMATION (continued)

## Sequential Timer

Many applications, such as computers, require signals for initializing conditions during start-up. Other applications, such as test equipment, require activation of test signals in sequence. These timing circuits can be connected to provide such sequential control. The timers can be used in various combinations of astable or monostable circuit connections, with or without modulation, for extremely flexible waveform control. Figure 22 shows a sequencer circuit with possible applications in many systems, and Figure 23 shows the output waveforms.


Pin numbers shown are for the D, JG, P, PS, and PW packages.
NOTE A: S closes momentarily at $t=0$.
Figure 22. Sequential Timer Circuit


Figure 23. Sequential Timer Waveforms

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JM38510/10901BPA | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| NA555D | ACTIVE | SOIC | D | 8 | 75 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NA555DG4 | ACTIVE | SOIC | D | 8 | 75 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no Sb/Br) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NA555DR | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NA555DRG4 | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NA555P | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| NA555PE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| NE555D | ACTIVE | SOIC | D | 8 | 75 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555DE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS \& no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| NE555DG4 | ACTIVE | SOIC | D | 8 | 75 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555DR | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555DRE4 | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555DRG4 | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \hline \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555P | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| NE555PE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| NE555PSLE | OBSOLETE | SO | PS | 8 |  | TBD | Call TI | Call TI |
| NE555PSR | ACTIVE | SO | PS | 8 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555PSRE4 | ACTIVE | SO | PS | 8 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555PW | ACTIVE | TSSOP | PW | 8 | 150 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555PWE4 | ACTIVE | TSSOP | PW | 8 | 150 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555PWR | ACTIVE | TSSOP | PW | 8 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| NE555PWRE4 | ACTIVE | TSSOP | PW | 8 | 2000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| NE555Y | OBSOLETE |  |  | 0 |  | TBD | Call TI | Call TI |
| SA555D | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br})$ | CU NIPDAU | Level-1-260C-UNLIM |
| SA555DE4 | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS \& no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SA555DG4 | ACTIVE | SOIC | D | 8 | 75 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |


| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing |  | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SA555DR | ACTIVE | SOIC | D | 8 | 2500 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br} \text { ) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| SA555DRE4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SA555DRG4 | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM |
| SA555P | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SA555PE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/ A for Pkg Type |
| SE555D | ACTIVE | SOIC | D | 8 | 75 | TBD | CU NIPDAU | Level-1-220C-UNLIM |
| SE555DR | ACTIVE | SOIC | D | 8 | 2500 | TBD | CU NIPDAU | Level-1-220C-UNLIM |
| SE555FKB | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SE555JG | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N/ A for Pkg Type |
| SE555JGB | ACTIVE | CDIP | JG | 8 | 1 | TBD | A42 SNPB | N/ A for Pkg Type |
| SE555N | OBSOLETE | PDIP | N | 8 |  | TBD | Call TI | Call TI |
| SE555P | ACTIVE | PDIP | P | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N/A for Pkg Type |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no $\mathbf{S b} / \mathbf{B r}$ ): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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JG (R-GDIP-T8)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification.
E. Falls within MIL STD 1835 GDIP1-T8

FK (S-CQCC-N**)


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-001

D (R-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed $0.006(0,15)$.
D. Falls within JEDEC MS-012 variation AA.

## MECHANICAL DATA

PS (R-PDSO-G8)
PLASTIC SMALL-OUTLINE PACKAGE
(
NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 .


| PIMS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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